



# PMV90ENE

30 V, N-channel Trench MOSFET

20 April 2016

Product data sheet

## 1. General description

N-channel enhancement mode Field-Effect Transistor (FET) in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

## 2. Features and benefits

- Logic level compatible
- Very fast switching
- Trench MOSFET technology
- ElectroStatic Discharge (ESD) protection > 2 kV HBM

## 3. Applications

- Relay driver
- High-speed line driver
- Low-side loadswitch
- Switching circuits

## 4. Quick reference data

Table 1. Quick reference data

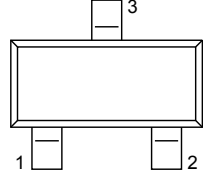
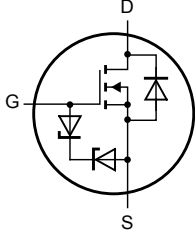
| Symbol                        | Parameter                        | Conditions  | Min | Typ | Max | Unit |
|-------------------------------|----------------------------------|---|-----|-----|-----|------|
| $V_{DS}$                      | drain-source voltage             | $T_j = 25\text{ °C}$  | -   | -   | 30  | V    |
| $V_{GS}$                      | gate-source voltage              |   | -20 | -   | 20  | V    |
| $I_D$                         | drain current                    | $V_{GS} = 10\text{ V}; T_{amb} = 25\text{ °C}; t \leq 5\text{ s}$ | [1] | -   | 3.7 | A    |
| <b>Static characteristics</b> |                                  |   |     |     |     |      |
| $R_{DS(on)}$                  | drain-source on-state resistance | $V_{GS} = 10\text{ V}; I_D = 3\text{ A}; T_j = 25\text{ °C}$      | -   | 54  | 72  | mΩ   |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.

nexperia

## 5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline  | Graphic symbol   |
|-----|--------|-------------|---|--|
| 1   | G      | gate        | <br>TO-236AB (SOT23) | <br>017aaa255 |
| 2   | S      | source      |   |  |
| 3   | D      | drain       |   |  |

## 6. Ordering information

Table 3. Ordering information

| Type number | Package  |  |         |
|-------------|----------|--|---------|
|             | Name     | Description                              | Version |
| PMV90ENE    | TO-236AB | plastic surface-mounted package; 3 leads | SOT23   |

## 7. Marking

Table 4. Marking codes

| Type number | Marking code |
|-------------|--------------|
| PMV90ENE    | %GH          |

[1] % = placeholder for manufacturing site code

## 8. Limiting values

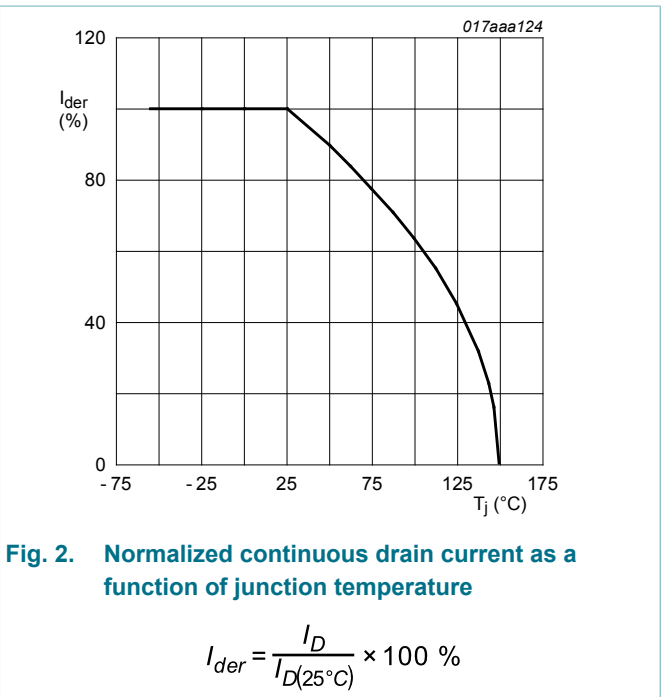
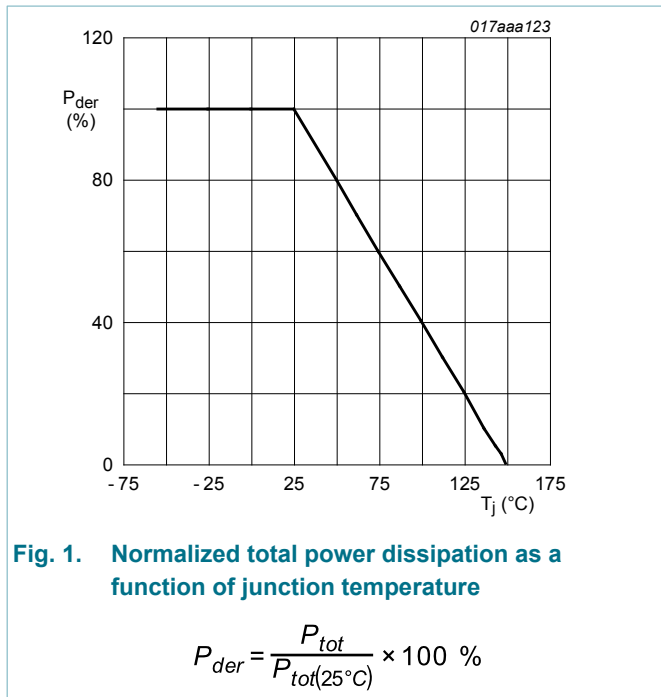
Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol    | Parameter               | Conditions  |     | Min | Max | Unit |
|-----------|-------------------------|---|-----|-----|-----|------|
| $V_{DS}$  | drain-source voltage    | $T_j = 25\text{ }^\circ\text{C}$  |     | -   | 30  | V    |
| $V_{GS}$  | gate-source voltage     |   |     | -20 | 20  | V    |
| $I_D$     | drain current           | $V_{GS} = 10\text{ V}; T_{amb} = 25\text{ }^\circ\text{C}; t \leq 5\text{ s}$             | [1] | -   | 3.7 | A    |
|           |                         | $V_{GS} = 10\text{ V}; T_{amb} = 25\text{ }^\circ\text{C}$                                | [1] | -   | 3   | A    |
|           |                         | $V_{GS} = 10\text{ V}; T_{amb} = 100\text{ }^\circ\text{C}$                               | [1] | -   | 1.9 | A    |
| $I_{DM}$  | peak drain current      | $T_{amb} = 25\text{ }^\circ\text{C}; \text{single pulse}; t_p \leq 10\text{ }\mu\text{s}$ |     | -   | 12  | A    |
| $P_{tot}$ | total power dissipation | $T_{amb} = 25\text{ }^\circ\text{C}$  | [2] | -   | 460 | mW   |

| Symbol                    | Parameter            | Conditions               |     | Min | Max | Unit |
|---------------------------|----------------------|--------------------------|-----|-----|-----|------|
|                           |                      |                          | [1] | -   | 1.1 | W    |
|                           |                      | T <sub>sp</sub> = 25 °C  |     | -   | 4.5 | W    |
| T <sub>j</sub>            | junction temperature |                          |     | -55 | 150 | °C   |
| T <sub>amb</sub>          | ambient temperature  |                          |     | -55 | 150 | °C   |
| T <sub>stg</sub>          | storage temperature  |                          |     | -65 | 150 | °C   |
| <b>Source-drain diode</b> |                      |                          |     |     |     |      |
| I <sub>s</sub>            | source current       | T <sub>amb</sub> = 25 °C | [1] | -   | 1   | A    |

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.
- [2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.



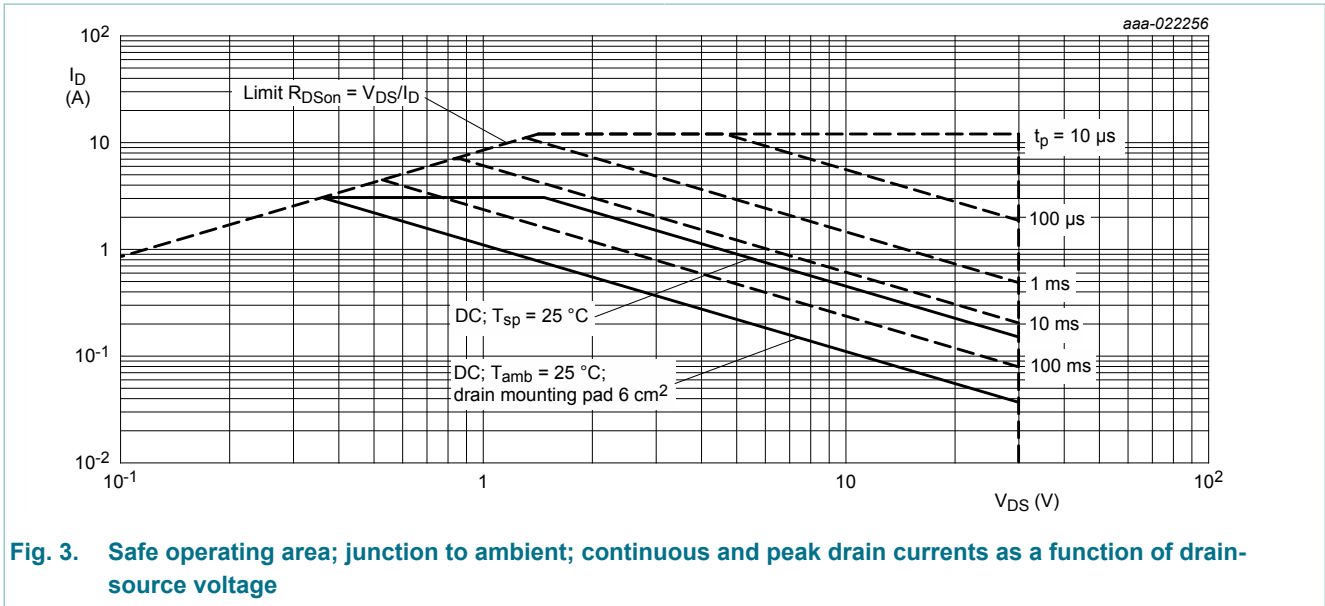


Fig. 3. Safe operating area; junction to ambient; continuous and peak drain currents as a function of drain-source voltage

## 9. Thermal characteristics

Table 6. Thermal characteristics

| Symbol         | Parameter  | Conditions   |     | Min | Typ | Max | Unit |
|----------------|--|--------------|-----|-----|-----|-----|------|
| $R_{th(j-a)}$  | thermal resistance from junction to ambient      | in free air  | [1] | -   | 227 | 270 | K/W  |
|                |  |              | [2] | -   | 99  | 115 | K/W  |
|                |  | $t \leq 5$ s | [2] | -   | 66  | 78  | K/W  |
| $R_{th(j-sp)}$ | thermal resistance from junction to solder point |              |     | -   | 20  | 28  | K/W  |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 cm<sup>2</sup>.

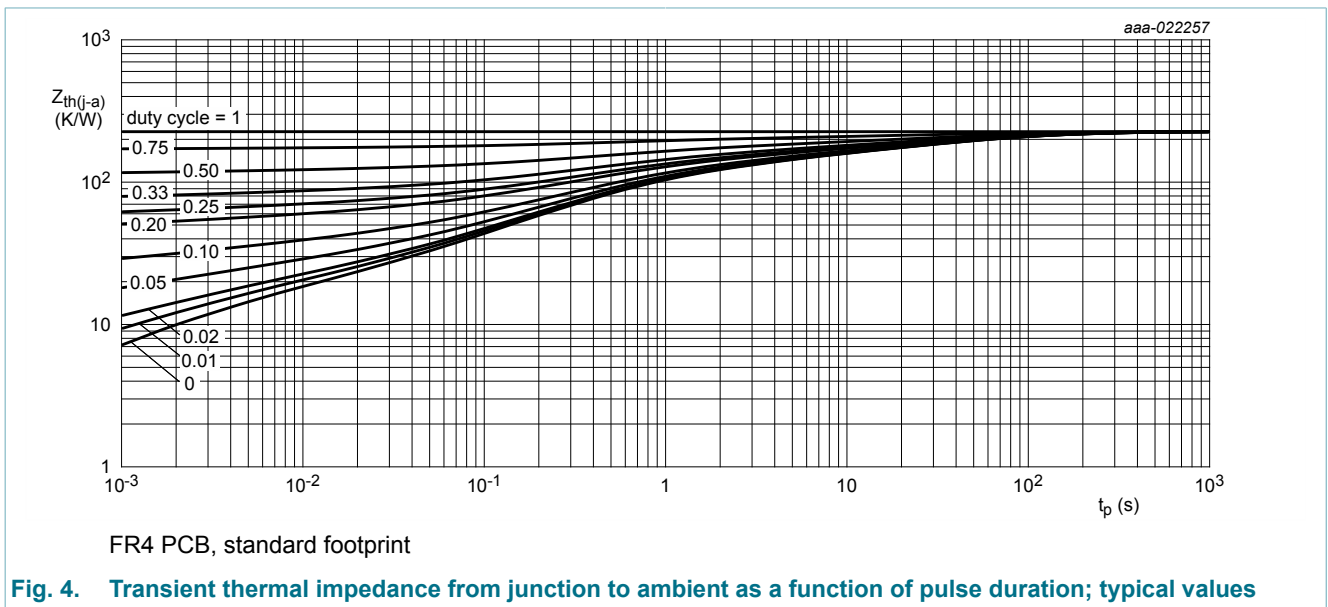
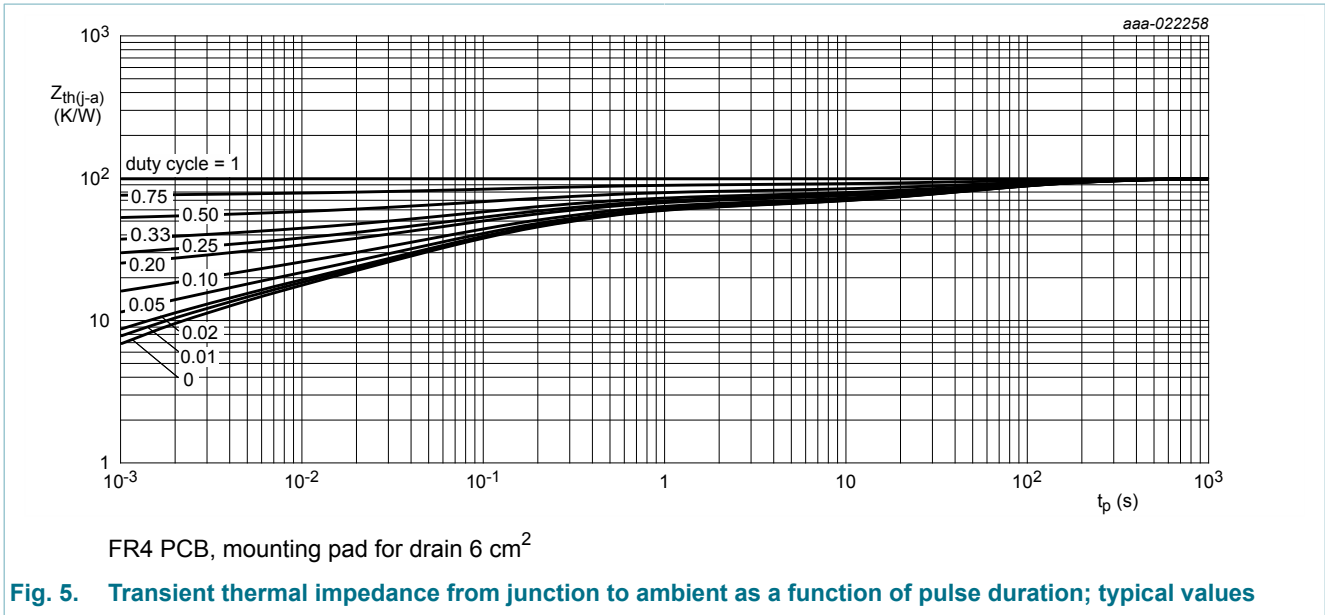


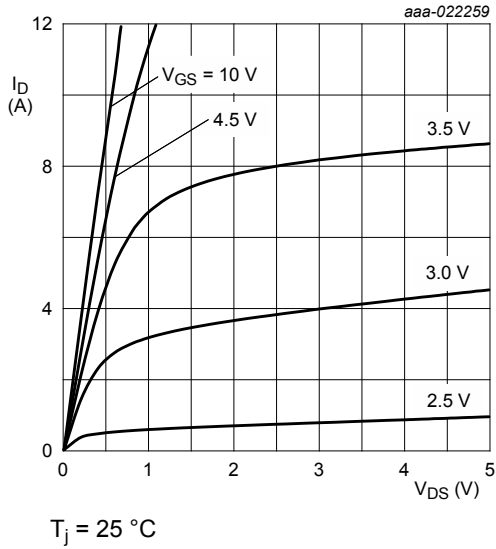
Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



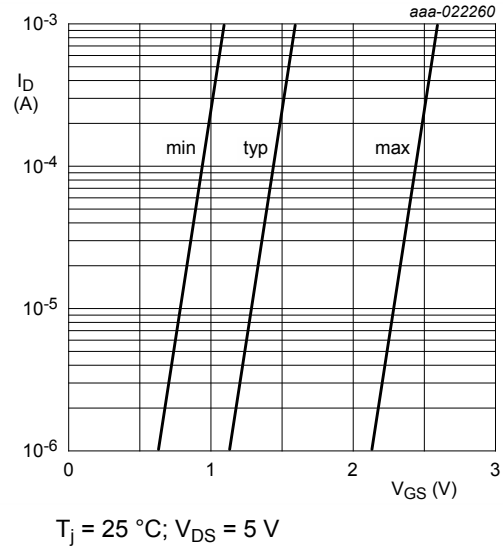
## 10. Characteristics

Table 7. Characteristics

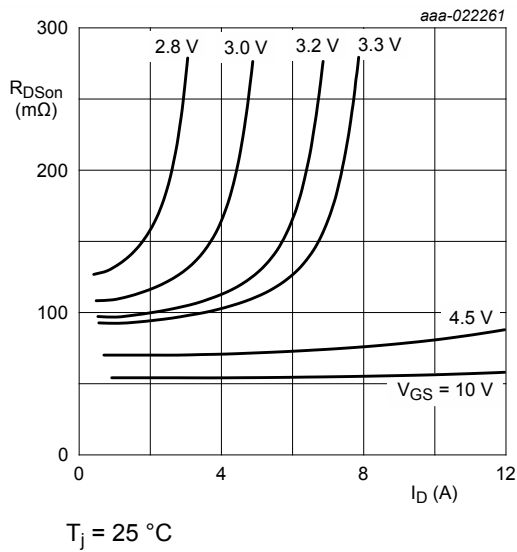
| Symbol                         | Parameter                        | Conditions  | Min  | Typ  | Max | Unit       |
|--------------------------------|----------------------------------|---|--|------|-----|------------|
| <b>Static characteristics</b>  |                                  |   |  |      |     |            |
| $V_{(BR)DSS}$                  | drain-source breakdown voltage   | $I_D = 250 \mu A$ ; $V_{GS} = 0 V$ ; $T_j = 25 \text{ }^\circ C$                        | 30   | -    | -   | V          |
| $V_{GSth}$                     | gate-source threshold voltage    | $I_D = 250 \mu A$ ; $V_{DS} = V_{GS}$ ; $T_j = 25 \text{ }^\circ C$                     | 1  | 1.5  | 2.5 | V          |
| $I_{DSS}$                      | drain leakage current            | $V_{DS} = 30 V$ ; $V_{GS} = 0 V$ ; $T_j = 25 \text{ }^\circ C$                          | -  | -    | 1   | $\mu A$    |
| $I_{GSS}$                      | gate leakage current             | $V_{GS} = 20 V$ ; $V_{DS} = 0 V$ ; $T_j = 25 \text{ }^\circ C$                          | -  | -    | 10  | $\mu A$    |
|                                |                                  | $V_{GS} = -20 V$ ; $V_{DS} = 0 V$ ; $T_j = 25 \text{ }^\circ C$                         | -  | -    | -10 | $\mu A$    |
|                                |                                  | $V_{GS} = 10 V$ ; $V_{DS} = 0 V$ ; $T_j = 25 \text{ }^\circ C$                          | -  | -    | 2   | $\mu A$    |
|                                |                                  | $V_{GS} = -10 V$ ; $V_{DS} = 0 V$ ; $T_j = 25 \text{ }^\circ C$                         | -  | -    | -2  | $\mu A$    |
| $R_{DSon}$                     | drain-source on-state resistance | $V_{GS} = 10 V$ ; $I_D = 3 A$ ; $T_j = 25 \text{ }^\circ C$                             | -  | 54   | 72  | m $\Omega$ |
|                                |                                  | $V_{GS} = 10 V$ ; $I_D = 3 A$ ; $T_j = 150 \text{ }^\circ C$                            | -  | 88   | 118 | m $\Omega$ |
|                                |                                  | $V_{GS} = 4.5 V$ ; $I_D = 2.6 A$ ; $T_j = 25 \text{ }^\circ C$                          | -  | 70   | 100 | m $\Omega$ |
| $g_{fs}$                       | forward transconductance         | $V_{DS} = 10 V$ ; $I_D = 3 A$ ; $T_j = 25 \text{ }^\circ C$                             | -  | 9    | -   | S          |
| $R_G$                          | gate resistance                  | $f = 1 \text{ MHz}$   | -  | 11.5 | -   | $\Omega$   |
| <b>Dynamic characteristics</b> |                                  |   |  |      |     |            |
| $Q_{G(tot)}$                   | total gate charge                | $V_{DS} = 15 V$ ; $I_D = 3 A$ ; $V_{GS} = 10 V$ ;<br>$T_j = 25 \text{ }^\circ C$        | -  | 3.6  | 5.5 | nC         |
| $Q_{GS}$                       | gate-source charge               |   | -  | 0.4  | -   | nC         |
| $Q_{GD}$                       | gate-drain charge                |   | -  | 0.7  | -   | nC         |
| $C_{iss}$                      | input capacitance                | $V_{DS} = 15 V$ ; $f = 1 \text{ MHz}$ ; $V_{GS} = 0 V$ ;<br>$T_j = 25 \text{ }^\circ C$ | -  | 160  | -   | pF         |
| $C_{oss}$                      | output capacitance               |   | -  | 33   | -   | pF         |
| $C_{riss}$                     | reverse transfer capacitance     |   | -  | 26   | -   | pF         |
| $t_{d(on)}$                    | turn-on delay time               |   | $V_{DS} = 15 V$ ; $I_D = 3 A$ ; $V_{GS} = 10 V$ ;<br>$R_{G(ext)} = 6 \Omega$ ; $T_j = 25 \text{ }^\circ C$ | -    | 6   | -          |
| $t_r$                          | rise time                        | -   |  | 6    | -   | ns         |
| $t_{d(off)}$                   | turn-off delay time              | -   |  | 11   | -   | ns         |
| $t_f$                          | fall time                        | -   |  | 4    | -   | ns         |
| <b>Source-drain diode</b>      |                                  |   |  |      |     |            |
| $V_{SD}$                       | source-drain voltage             | $I_S = 1 A$ ; $V_{GS} = 0 V$ ; $T_j = 25 \text{ }^\circ C$                              | -  | 0.8  | 1.2 | V          |



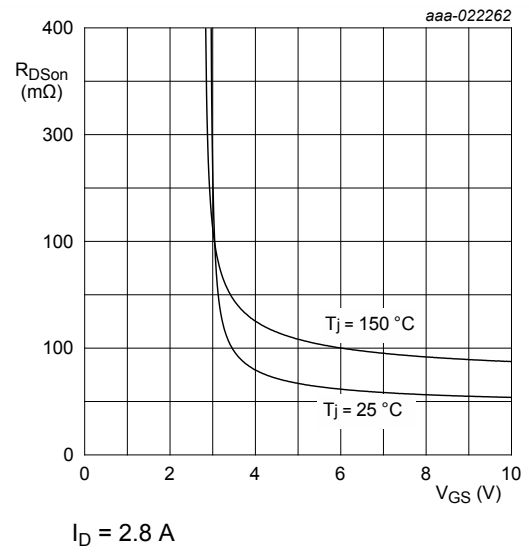
**Fig. 6. Output characteristics: drain current as a function of drain-source voltage; typical values**



**Fig. 7. Sub-threshold drain current as a function of gate-source voltage**

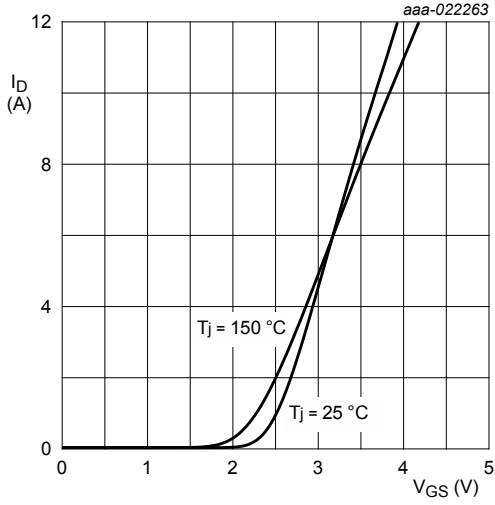


**Fig. 8. Drain-source on-state resistance as a function of drain current; typical values**



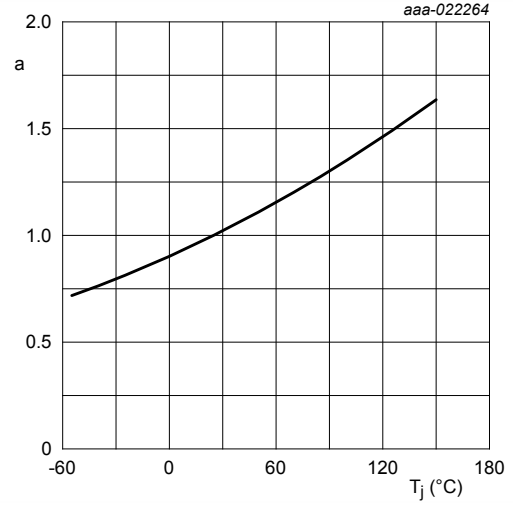
**Fig. 9. Drain-source on-state resistance as a function of gate-source voltage; typical values**





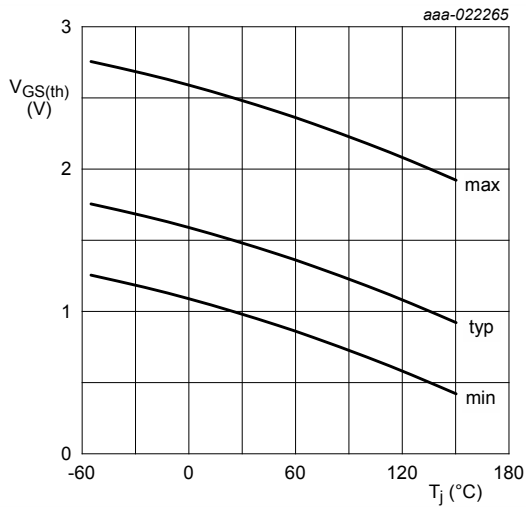
$$V_{DS} > I_D \times R_{DSon}$$

**Fig. 10. Transfer characteristics: drain current as a function of gate-source voltage; typical values**



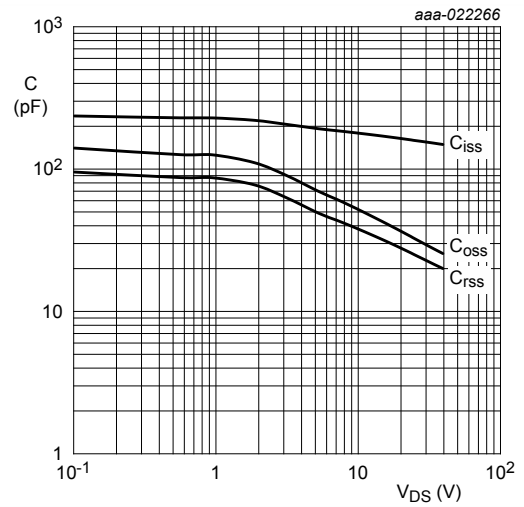
**Fig. 11. Normalized drain-source on-state resistance as a function of junction temperature; typical values**

$$a = \frac{R_{DSon}}{R_{DSon(25^\circ C)}}$$



$$I_D = 0.25 \text{ mA}; V_{DS} = V_{GS}$$

**Fig. 12. Gate-source threshold voltage as a function of junction temperature**



$$f = 1 \text{ MHz}; V_{GS} = 0 \text{ V}$$

**Fig. 13. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values**

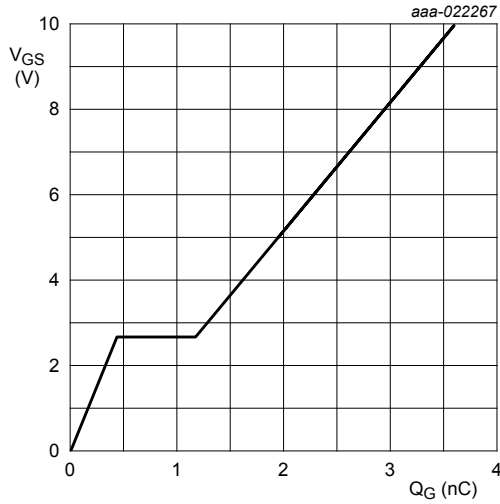


Fig. 14. Gate-source voltage as a function of gate charge; typical values

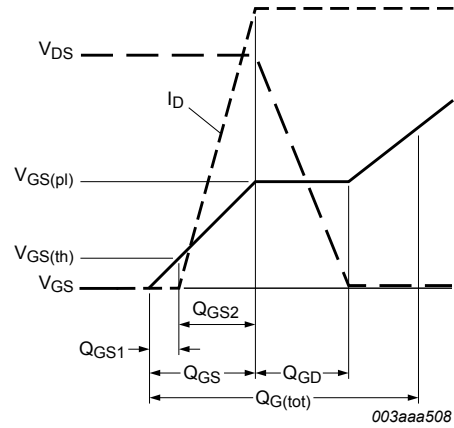


Fig. 15. MOSFET transistor: Gate charge waveform definitions

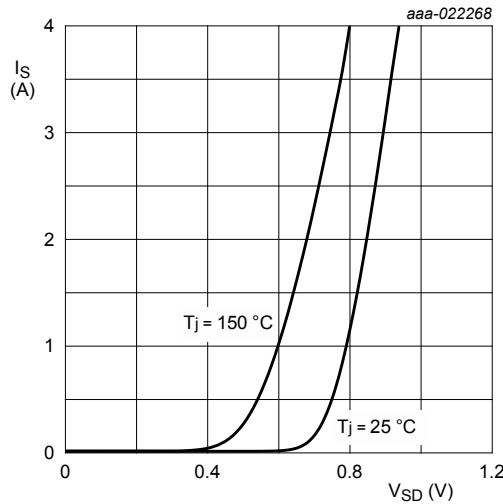


Fig. 16. Source current as a function of source-drain voltage; typical values

## 11. Test information

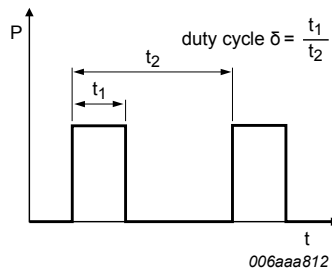


Fig. 17. Duty cycle definition

## 12. Package outline

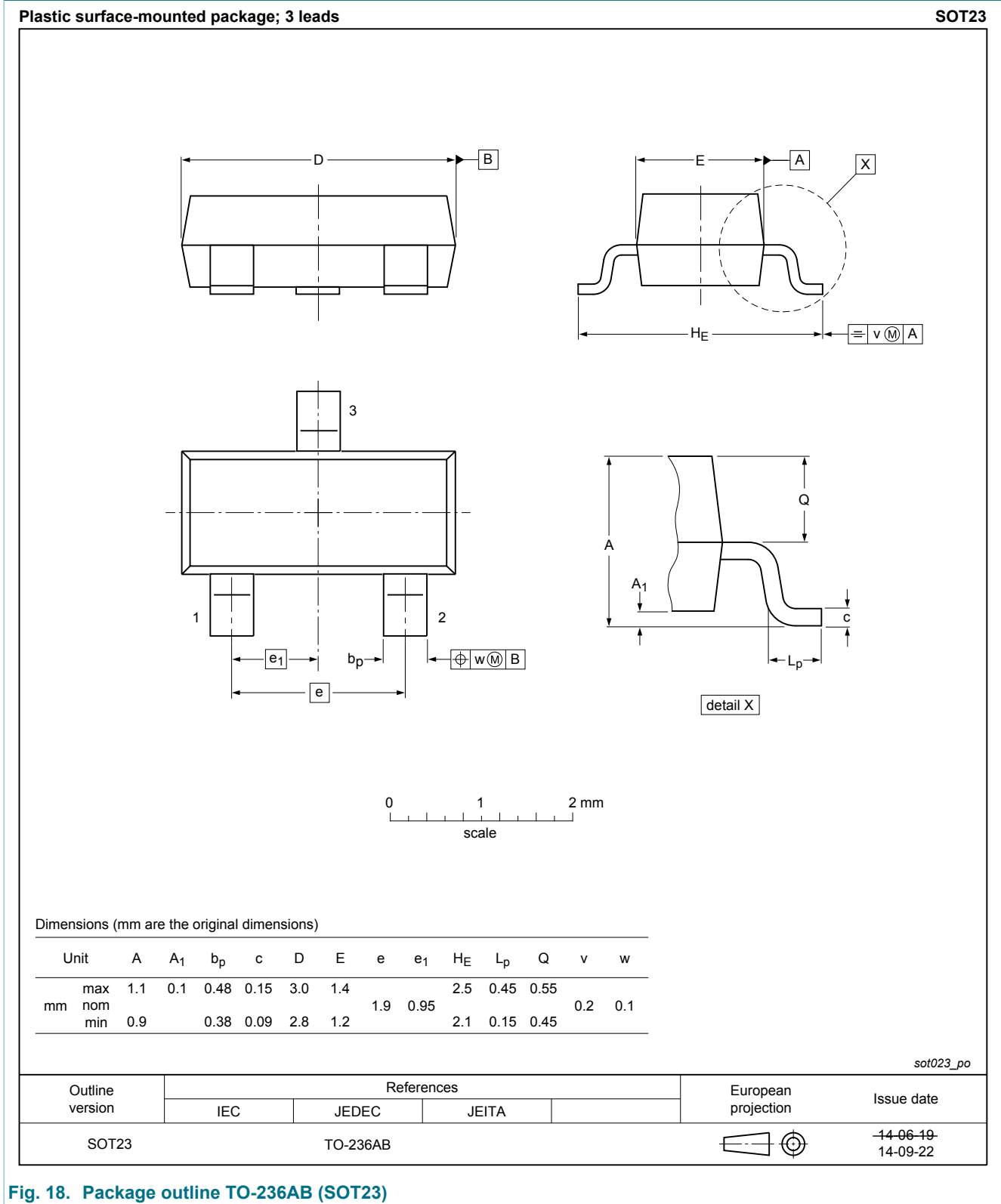


Fig. 18. Package outline TO-236AB (SOT23)

### 13. Soldering



Fig. 19. Reflow soldering footprint for TO-236AB (SOT23)



Fig. 20. Wave soldering footprint for TO-236AB (SOT23)

### 14. Revision history

Table 8. Revision history

| Data sheet ID | Release date | Data sheet status  | Change notice | Supersedes |
|---------------|--------------|--------------------|---------------|------------|
| PMV90ENE v.1  | 20160420     | Product data sheet | -             | -          |

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| Document status [1][2]         | Product status [3] | Definition  |
|--------------------------------|--------------------|---|
| Objective [short] data sheet   | Development        | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification      | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production         | This document contains the product specification.                                     |

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- [2] The term 'short data sheet' is explained in section "Definitions".
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